

## MOTIVATION

Since the beginning of the last decade the international haptics research community has enjoyed a healthy and steady growth. This is reflected in an exponential increase in haptics publications as well as in the development of three major international conferences dedicated to haptics research: Symposium on Haptic Interfaces for Virtual Environment and Teleoperator Systems, EuroHaptics, and World Haptics Conference. The time is ripe to bring the multidisciplinary international haptics research community together to debate challenges and opportunities in haptics research, and to make concerted efforts towards experimental, theoretical, and algorithmic breakthroughs in this growing field. In October 2006, a proposal for a new Technical Committee (TC) on Haptics was approved by the IEEE Robotics and Automation Society. In November 2007, a proposal for a Task Force (TF) on Haptics was approved by the IEEE Computer Society.

## MISSION

The goals of the IEEE Haptics TC/TF are to integrate the diverse interests of the highly interdisciplinary haptics research community and to improve communication

among the different fields. It will serve to coordinate the scheduling of major haptics conferences, facilitate special conference sessions and journal issues on haptics, organize tutorials focused on haptics, and contribute towards a new IEEE Transactions on Haptics.

## GETTING INVOLVED

Membership in the IEEE Haptics TC/TF is free and open to all individuals interested in haptics research at a professional level. There are no fees for membership. IEEE membership is not required for joining the Haptics TC/TF.

## WEB SITE

Visit the IEEE Haptics TC/TF web site at <http://www.worldhaptics.org> for more information. Details are provided about how to join, the scope of the TC/TF, haptics conferences, sessions and tutorials on haptics at other conferences, special journal issues on haptics, and other related activities.

Hong Z. Tan, Chair  
Matthias Harders, Co-Chair  
Hiroyuki Kajimoto, Co-Chair

## IEEE Haptics TC/TF Executive Committee

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